## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE ration of:

In re Application of:

Mei Chang et al.

Serial No.: 10/634,662

Confirmation No.: 6355

Filed:

August 4, 2003

For: Ruthenium Layer

Formation for Copper Film Deposition

MAIL STOP AMENDMENT Commissioner for Patents P.O. Box 1450

Alexandria, VA 22313-1450

Dear Sir

Group Art Unit: 1762

Examiner: Kelly M. Stouffer

## CERTIFICATE OF TRANSMISSION

I hereby certify that this correspondence is being electronically transmitted to the U.S. Patent and Trademark Office via EFS-Web to the attention of Examiner Kelly M. Stouffer, on the date shown below.

January 10, 2007

John-Paul F. Cherry

## RESPONSE TO OFFICE ACTION DATED OCTOBER 10, 2006

In response to the Office Action dated October 10, 2006, having a shortened statutory period for response set to expire on January 10, 2007, please enter this Response and reconsider the claims pending in the application for the reasons discussed below. The attached fee transmittal form provides authorization to the Commissioner to charge the Applicant for the terminal disclaimer fee. Although the Applicant believes that no additional fees are due in connection with this Response, the Commissioner is hereby authorized to charge counsel's Deposit Account No. 20-0782/APPM/005975.P1/JPC, for any fees, including extension of time fees or excess claim fees, required to make this Response timely and acceptable to the Office.

Amendments to the Claims begin on page 2 of this paper. Remarks begin on page 12 of this paper.